

Self Control Protector (SCP) - SFR 12A Series Datasheet -

Dexerials Corporation

2024/09/13



The technical data in this document, which was acquired on the basis of reliable tests, does not guarantee full performance as in the document in any stance. Users assume total responsibility and risk for their use of this product for any purposes of use under any use conditions.



Table of Contents

	Pages
Table of Contents	2
SFR series Specification	3
Dimensions & Equivalent Circuit	4
Terminal Size & Reflow Soldering profile	5
Current Operation	6
Voltage Operation	7
Current Carrying Capacity	9
Handling of data in this document	10
Notice	11

SFR-12Ampere series Specification

Products Lineup

Applicable Cells in series	1 cell	2 cells	
Product	SFR-0412C	SFR-0812C	
Rated Current	12 A		
Size	2.7 ^{±0.2} x 1.8 ^{±0.2} x 0.75 ^{±0.1} mm		
Fuse Resistance (Typical)	2.6 m-ohm		
Operating Voltage	3.5 – 4.7 V	6.0-9.2 V	
Heater Resistance	1.01 - 1.53 ohm	3.4 – 4.8 ohm	
Marking	12A R1C	12A R2C	

Items		General Specification			
Environmental Compliance		Compliance with RoHS			
Halogen Free		Bromine (Br)=900 ppm or less, Chlorine (Cl)=900 ppm or less, Br + Cl=1500 ppm or less (By weight)			
Antimony Free		700 ppm or less			
Lead Free		1000 ppm or less			
Qualification		UL248-14 (File No. E167588), TUV (Certificate No. J9650637)			
Rated Breaking Capacity Rated Voltage	eaking Capacity UL 50 A at 36 VDC Ditage This value is the maximum voltage can be cut off by fuse. It doesn't represent the				
	TUV	50 A at 36 VDC This value is the maximum voltage can be cut off by fuse. It doesn't represent the operational voltage of the heater.			
Re-flow Temp.(MAX)		260 °C			

*Caution: The specification may be subject to change without prior notice in the future.

External View & Equivalent Circuit

Product Name	External View	Equivalent Circuit
SFR-xx12C	<pre><rp></rp></pre> < Side View> (2) (1) (1) (1) (1) (1) (1) (1) (1) (1) (1	(1) (2) (2) (3) (1)

Terminal Size & Reflow Soldering

• Terminal Size (unit: mm. Not in scale)



• Reflow Soldering Profile(Temperature shown below is measured at the electrode portion of SCP.)



Current Operation



*Caution: These are standard values, and they may be subject to change without prior notice in the future.

Heater Operation



(*Note) This is the typical evaluation value with our PCB (0.6 mm thickness glass-epoxy single-sided copper-clad laminates). (*Caution)The specification may be subject to change without prior notice in the future.

Cut By Heater Voltage at 25°C



(*Note) This is the typical evaluation value with our PCB (0.6 mm thickness glass-epoxy single-sided copper-clad laminates). (*Caution)The specification may be subject to change without prior notice in the future.

Current Carrying Capacity

Product Name	Nominal Rated Current	Current-Carrying Capacity (*1)			Current Rush Withstand
		25 °C	40 °C	60 °C	(*2)
SFR-xx12C	12 A	15 A	13.5 A	11 A	48 A-10 ms

(*Note)

- 1. This is the standard value derived from a temperature of 100 degrees Celsius, a temperature at which we have verified the reliability using our company's standard PCB (0.6t Glass Epoxy single-sided copper-clad laminates). The thermal capacity of the PCB can affect it, so we recommend verifying it with your specific PCB.
 - -> 25 °C, 40 °C and 60 °C are ambient temperature.
 - -> The temperature at which we verified reliability is not a critical condition. SCP fusing-off temperature is 200 °C or more.
- -> The current-carrying capacity is measured under thermal equilibrium conditions. Therefore, if the duration of current-carrying is short, the current-carrying capacity will increase.
- 2. Reliability was confirmed under the test conditions (10ms-On, 9990ms-Off, 500cycle). However, this does not mean critical conditions for SCP.

Handling of data in this document

- 1. Please confirm the latest product information before a design.
 - You can confirm the latest information about SCP on the following website.
 - <u>http:// www.dexerials.jp/en/products/c3/</u>
- 2. SCP complies with following environmental regulation.
 - 1) RoHS.
 - 2) General requirement for Halogen Free.
- 3. These data are typical values.
 - 1) These data is not a guaranteed value.
 - 2) These data is measured with our company's standard PCB (0.6t Glass Epoxy single-sided copper-clad laminates). The characteristics are influenced by thermal capacity of PCB. Generally, as the thermal capacity of the PCB increases, the current-carrying capacity will also increase, and the clearing time will be longer.
- 4. Please select the product based on[Current-carrying capacity] and [Heater operation characteristics].
 - 1) Nominal rated current is provided based on UL standard (The maximum temperature rise on body or contact that is passed the current shall not exceed 75°C) and so it is not Current-carrying capacity. Therefore, please select a product based on Current- carrying capacity instead of Nominal rated current.
 - 2) [Current-carrying capacity] and [Heater operation characteristics] are influenced by thermal capacity of PCB and so on. Therefore, we recommend checking it on your PCB.
 - 3) We can perform tests using your printed circuit boards (current-carrying characteristics, clearing characteristics, etc.).Please feel free to contact us.
- 5. Current-carrying capacity
 - 1) The current-carrying capacity is the value at which SCP reaches the temperature that we have verified for reliability within our company.
 - 2) The temperature at which we have confirmed reliability is 100 degrees Celsius. However, this is not a critical condition for SCP. For
 instance, if SCP's temperature exceeds this, it does not immediately fuse off like a typical thermal fuse. SCP's fusing-off temperature is 200
 degrees Celsius or higher, indicating that it has a significant capacity to withstand temperature increases.
 - 3) The current-carrying capacity is measured under thermal equilibrium conditions. Therefore, if the duration of current-carrying is short, the current-carrying capacity will increase.
 - 6. Precautions regarding handling
 - 1) Make sure that the terminals of this product are connected on the lands of the circuit board, and that the heater resistance is rated value.
 - 2) Ultrasonic cleaning, immersion cleaning, and similar methods should not be applied to SCP either before or after mounting. If cleaning is performed, the flux on the element could flow, potentially causing it to fail to meet its specifications. Additionally, similar influence can occur when the product comes into contact with a cleaning solution. Any products cleaned in this manner will not be guaranteed.
 - 3) Please avoid contacting SCP and resin-mold. The resin might infiltrate into the product, and it doesn't meet the specification when the resin-mold is done to this product. These products after resin-mold will not be guaranteed.
 - 4) Please do not re-use of the SCP that removed by the solder correction.
 - 5) SCP should be stored in a shaded, low-dust area with a temperature of 40°C or lower, without sudden temperature changes. The
 relative humidity should be 60% or less, and the air should be free of corrosive gases. Under these conditions, the maximum storage period is
 1 year from the delivery date.



Notice

The test fixtures and test results described in this document are reference information provided by Dexerials Corporation for the benefit of customers purchasing this product.

Dexerials Corporation does not warrant to the Customer or any third party that the test results, etc. are error-free. Dexerials Corporation shall not be liable for any loss or damage incurred by customer or any third party due to errors in the test results, etc., unless such errors are caused by Dexerials Corporation's willful misconduct or gross negligence.

If you require a delivery specification sheet describing the shipping inspection data of this product, please contact Dexerials Corporation.

Before using this product, please read this document carefully to ensure that you fully understand its contents. The contents of this document are correct at the time of publication and are subject to change without notice. Please be sure to confirm the contents of the latest version.

In the event of any conflict between the contents of this document and any other contents (whether written or oral), the contents of this document shall prevail.

Dexerials Corporation assumes no responsibility for any malfunction, failure, or accident resulting from the use of this product in violation of the precautions described in this document or in the instruction manual of this product.

When considering the use of the product in equipment or devices (medical equipment, transportation equipment, traffic equipment, aerospace equipment, nuclear power control equipment, fuel control, various safety devices, etc.) that require extremely high reliability and whose failure or malfunction could result in danger or damage to human life or body, or other serious damage, the product should be fully verified through prior evaluation and considered for implementation at the customer's own risk. This product is not designed to be mounted on weapons, weapons of mass destruction, parts or accessories of weapons.

This material is copyrighted by Dexerials Corporation. Unauthorized reproduction or distribution of this material is prohibited.